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Understanding [Embedded - DSP \(Digital Signal Processors\)](#)

[Embedded - DSP \(Digital Signal Processors\)](#) are specialized microprocessors designed to perform complex mathematical computations on digital signals in real-time. Unlike general-purpose processors, DSPs are optimized for high-speed numeric processing tasks, making them ideal for applications that require efficient and precise manipulation of digital data. These processors are fundamental in converting and processing signals in various forms, including audio, video, and communication signals, ensuring that data is accurately interpreted and utilized in embedded systems.

Applications of [Embedded - DSP \(Digital Signal Processors\)](#)

Details	
Product Status	Active
Type	Floating Point
Interface	EBI/EMI, DAI, I ² C, SPI, SPORT, UART/USART
Clock Rate	450MHz
Non-Volatile Memory	External
On-Chip RAM	5Mbit
Voltage - I/O	3.30V
Voltage - Core	1.10V
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	176-LQFP Exposed Pad
Supplier Device Package	176-LQFP-EP (24x24)
Purchase URL	https://www.e-xfl.com/product-detail/analog-devices/adsp-21489kswz-5b

ADSP-21483/ADSP-21486/ADSP-21487/ADSP-21488/ADSP-21489

The diagram on [Page 1](#) shows the two clock domains that make up the ADSP-2148x processors. The core clock domain contains the following features:

- Two processing elements (PE_x, PE_y), each of which comprises an ALU, multiplier, shifter, and data register file
- Data address generators (DAG1, DAG2)
- Program sequencer with instruction cache
- PM and DM buses capable of supporting 2x64-bit data transfers between memory and the core at every core processor cycle
- One periodic interval timer with pinout
- On-chip SRAM (5 Mbit) and mask-programmable ROM (4 Mbit)
- JTAG test access port for emulation and boundary scan. The JTAG provides software debug through user breakpoints which allows flexible exception handling.

The block diagram of the ADSP-2148x on [Page 1](#) also shows the peripheral clock domain (also known as the I/O processor) which contains the following features:

- IOD0 (peripheral DMA) and IOD1 (external port DMA) buses for 32-bit data transfers
- Peripheral and external port buses for core connection
- External port with an AMI and SDRAM controller
- 4 units for PWM control
- 1 memory-to-memory (MTM) unit for internal-to-internal memory transfers
- Digital applications interface that includes four precision clock generators (PCG), an input data port (IDP/PDAP) for serial and parallel interconnects, an S/PDIF receiver/transmitter, four asynchronous sample rate converters, eight serial ports, and a flexible signal routing unit (DAI SRU).
- Digital peripheral interface that includes two timers, a 2-wire interface (TWI), one UART, two serial peripheral interfaces (SPI), 2 precision clock generators (PCG), pulse width modulation (PWM), and a flexible signal routing unit (DPI SRU2).

As shown in the SHARC core block diagram on [Page 5](#), the processor uses two computational units to deliver a significant performance increase over the previous SHARC processors on a range of DSP algorithms. With its SIMD computational hardware, the processors can perform 2.7 GFLOPS running at 450 MHz.

FAMILY CORE ARCHITECTURE

The ADSP-2148x is code compatible at the assembly level with the ADSP-2147x, ADSP-2146x, ADSP-2137x, ADSP-2136x, ADSP-2126x, ADSP-21160, and ADSP-21161, and with the first generation ADSP-2106x SHARC processors. The ADSP-2148x shares architectural features with the ADSP-2126x, ADSP-2136x, ADSP-2137x, ADSP-2146x and ADSP-2116x SIMD SHARC processors, as shown in [Figure 2](#) and detailed in the following sections.

SIMD Computational Engine

The ADSP-2148x contains two computational processing elements that operate as a single-instruction, multiple-data (SIMD) engine. The processing elements are referred to as PEX and PEY and each contains an ALU, multiplier, shifter, and register file. PEX is always active, and PEY may be enabled by setting the PEYEN mode bit in the MODE1 register. SIMD mode allows the processor to execute the same instruction in both processing elements, but each processing element operates on different data. This architecture is efficient at executing math intensive DSP algorithms.

SIMD mode also affects the way data is transferred between memory and the processing elements because twice the data bandwidth is required to sustain computational operation in the processing elements. Therefore, entering SIMD mode also doubles the bandwidth between memory and the processing elements. When using the DAGs to transfer data in SIMD mode, two data values are transferred with each memory or register file access.

Independent, Parallel Computation Units

Within each processing element is a set of computational units. The computational units consist of an arithmetic/logic unit (ALU), multiplier, and shifter. These units perform all operations in a single cycle and are arranged in parallel, maximizing computational throughput. Single multifunction instructions execute parallel ALU and multiplier operations. In SIMD mode, the parallel ALU and multiplier operations occur in both processing elements. These computation units support IEEE 32-bit single-precision floating-point, 40-bit extended precision floating-point, and 32-bit fixed-point data formats.

Timer

The processor contains a core timer that can generate periodic software interrupts. The core timer can be configured to use FLAG3 as a timer expired signal.

Data Register File

Each processing element contains a general-purpose data register file. The register files transfer data between the computation units and the data buses, and store intermediate results. These 10-port, 32-register (16 primary, 16 secondary) register files, combined with the processor's enhanced Harvard architecture, allow unconstrained data flow between computation units and internal memory. The registers in PEX are referred to as R0–R15 and in PEY as S0–S15.

Context Switch

Many of the processor's registers have secondary registers that can be activated during interrupt servicing for a fast context switch. The data registers in the register file, the DAG registers, and the multiplier result registers all have secondary registers. The primary registers are active at reset, while the secondary registers are activated by control bits in a mode control register.

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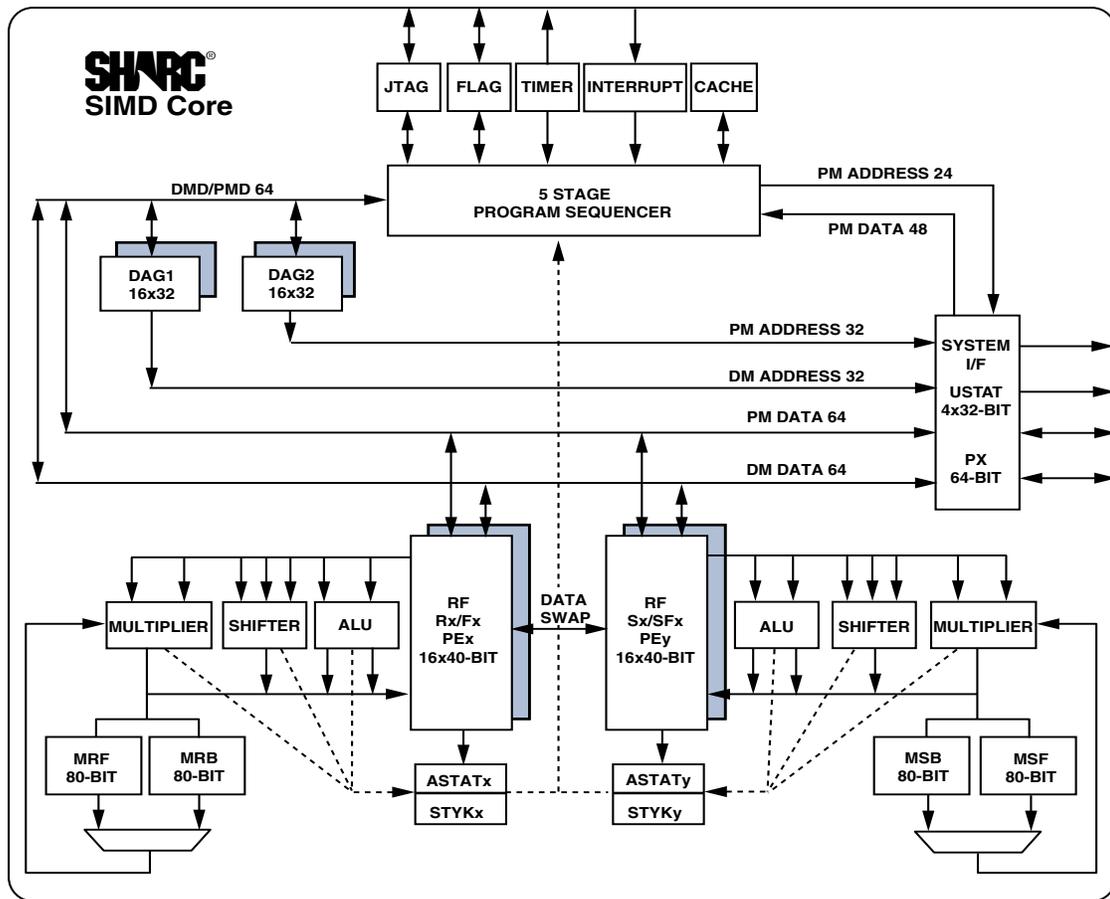


Figure 2. SHARC Core Block Diagram

Universal Registers

These registers can be used for general-purpose tasks. The USTAT (4) registers allow easy bit manipulations (Set, Clear, Toggle, Test, XOR) for all peripheral registers (control/status).

The data bus exchange register (PX) permits data to be passed between the 64-bit PM data bus and the 64-bit DM data bus, or between the 40-bit register file and the PM/DM data bus. These registers contain hardware to handle the data width difference.

Single-Cycle Fetch of Instruction and Four Operands

The ADSP-2148x features an enhanced Harvard architecture in which the data memory (DM) bus transfers data and the program memory (PM) bus transfers both instructions and data. With its separate program and data memory buses and on-chip instruction cache, the processor can simultaneously fetch four operands (two over each data bus) and one instruction (from the cache), all in a single cycle.

Instruction Cache

The processor includes an on-chip instruction cache that enables three-bus operation for fetching an instruction and four data values. The cache is selective—only the instructions whose

fetches conflict with PM bus data accesses are cached. This cache allows full speed execution of core, looped operations such as digital filter multiply-accumulates, and FFT butterfly processing.

Data Address Generators With Zero-Overhead Hardware Circular Buffer Support

The two data address generators (DAGs) are used for indirect addressing and implementing circular data buffers in hardware. Circular buffers allow efficient programming of delay lines and other data structures required in digital signal processing, and are commonly used in digital filters and Fourier transforms. The two DAGs contain sufficient registers to allow the creation of up to 32 circular buffers (16 primary register sets, 16 secondary). The DAGs automatically handle address pointer wraparound, reduce overhead, increase performance, and simplify implementation. Circular buffers can start and end at any memory location.

Flexible Instruction Set

The 48-bit instruction word accommodates a variety of parallel operations, for concise programming. For example, the processor can conditionally execute a multiply, an add, and a

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subtract in both processing elements while branching and fetching up to four 32-bit values from memory, all in a single instruction.

Variable Instruction Set Architecture (VISA)

In addition to supporting the standard 48-bit instructions from previous SHARC processors, the ADSP-2148x supports new instructions of 16 and 32 bits. This feature, called Variable Instruction Set Architecture (VISA), drops redundant/unused bits within the 48-bit instruction to create more efficient and compact code. The program sequencer supports fetching these 16-bit and 32-bit instructions from both internal and external

SDRAM memory. This support is not extended to the asynchronous memory interface (AMI). Source modules need to be built using the VISA option, in order to allow code generation tools to create these more efficient opcodes.

On-Chip Memory

The ADSP-21483 and the ADSP-21488 processors contain 3 Mbits of internal RAM (Table 3) and the ADSP-21486, ADSP-21487, and ADSP-21489 processors contain 5 Mbits of internal RAM (Table 4). Each memory block supports single-cycle, independent accesses by the core processor and I/O processor.

Table 3. Internal Memory Space (3 Mbits—ADSP-21483/ADSP-21488)¹

IOP Registers 0x0000 0000–0x0003 FFFF			
Long Word (64 Bits)	Extended Precision Normal or Instruction Word (48 Bits)	Normal Word (32 Bits)	Short Word (16 Bits)
Block 0 ROM (Reserved) 0x0004 0000–0x0004 7FFF	Block 0 ROM (Reserved) 0x0008 0000–0x0008 AAA9	Block 0 ROM (Reserved) 0x0008 0000–0x0008 FFFF	Block 0 ROM (Reserved) 0x0010 0000–0x0011 FFFF
Reserved 0x0004 8000–0x0004 8FFF	Reserved 0x0008 AAAA–0x0008 BFFF	Reserved 0x0009 0000–0x0009 1FFF	Reserved 0x0012 0000–0x0012 3FFF
Block 0 SRAM 0x0004 9000–0x0004 CFFF	Block 0 SRAM 0x0008 C000–0x0009 1554	Block 0 SRAM 0x0009 2000–0x0009 9FFF	Block 0 SRAM 0x0012 4000–0x0013 3FFF
Reserved 0x0004 D000–0x0004 FFFF	Reserved 0x0009 1555–0x0009 FFFF	Reserved 0x0009 A000–0x0009 FFFF	Reserved 0x0013 4000–0x0013 FFFF
Block 1 ROM (Reserved) 0x0005 0000–0x0005 7FFF	Block 1 ROM (Reserved) 0x000A 0000–0x000A AAA9	Block 1 ROM (Reserved) 0x000A 0000–0x000A FFFF	Block 1 ROM (Reserved) 0x0014 0000–0x0015 FFFF
Reserved 0x0005 8000–0x0005 8FFF	Reserved 0x000A AAAA–0x000A BFFF	Reserved 0x000B 0000–0x000B 1FFF	Reserved 0x0016 0000–0x0016 3FFF
Block 1 SRAM 0x0005 9000–0x0005 CFFF	Block 1 SRAM 0x000A C000–0x000B 1554	Block 1 SRAM 0x000B 2000–0x000B 9FFF	Block 1 SRAM 0x0016 4000–0x0017 3FFF
Reserved 0x0005 D000–0x0005 FFFF	Reserved 0x000B 1555–0x000B FFFF	Reserved 0x000B A000–0x000B FFFF	Reserved 0x0017 4000–0x0017 FFFF
Block 2 SRAM 0x0006 0000–0x0006 1FFF	Block 2 SRAM 0x000C 0000–0x000C 2AA9	Block 2 SRAM 0x000C 0000–0x000C 3FFF	Block 2 SRAM 0x0018 0000–0x0018 7FFF
Reserved 0x0006 2000–0x0006 FFFF	Reserved 0x000C 2AAA–0x000D FFFF	Reserved 0x000C 4000–0x000D FFFF	Reserved 0x0018 8000–0x001B FFFF
Block 3 SRAM 0x0007 0000–0x0007 1FFF	Block 3 SRAM 0x000E 0000–0x000E 2AA9	Block 3 SRAM 0x000E 0000–0x000E 3FFF	Block 3 SRAM 0x001C 0000–0x001C 7FFF
Reserved 0x0007 2000–0x0007 FFFF	Reserved 0x000E 2AAA–0x000F FFFF	Reserved 0x000E 4000–0x000F FFFF	Reserved 0x001C 8000–0x001F FFFF

¹ Some ADSP-2148x processors include a customer-definable ROM block. ROM addresses on these models are not reserved as shown in this table. Please contact your Analog Devices sales representative for additional details.

The processor's SRAM can be configured as a maximum of 160k words of 32-bit data, 320k words of 16-bit data, 106.7k words of 48-bit instructions (or 40-bit data), or combinations of different word sizes up to 5 megabits. All of the memory can be accessed as 16-bit, 32-bit, 48-bit, or 64-bit words. A 16-bit floating-point storage format is supported that effectively doubles the amount of data that may be stored on-chip. Conversion between the 32-bit floating-point and 16-bit floating-point formats is performed in a single instruction. While each memory block can store combinations of code and data, accesses are

most efficient when one block stores data using the DM bus for transfers, and the other block stores instructions and data using the PM bus for transfers.

Using the DM bus and PM buses, with one bus dedicated to a memory block, assures single-cycle execution with two data transfers. In this case, the instruction must be available in the cache.

The memory maps in Table 3 and Table 4 display the internal memory address space of the processors. The 48-bit space section describes what this address range looks like to an

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Table 4. Internal Memory Space (5 MBits—ADSP-21486/ADSP-21487/ADSP-21489)¹

IOP Registers 0x0000 0000–0x0003 FFFF			
Long Word (64 Bits)	Extended Precision Normal or Instruction Word (48 Bits)	Normal Word (32 Bits)	Short Word (16 Bits)
Block 0 ROM (Reserved) 0x0004 0000–0x0004 7FFF	Block 0 ROM (Reserved) 0x0008 0000–0x0008 AAA9	Block 0 ROM (Reserved) 0x0008 0000–0x0008 FFFF	Block 0 ROM (Reserved) 0x0010 0000–0x0011 FFFF
Reserved 0x0004 8000–0x0004 8FFF	Reserved 0x0008 AAAA–0x0008 BFFF	Reserved 0x0009 0000–0x0009 1FFF	Reserved 0x0012 0000–0x0012 3FFF
Block 0 SRAM 0x0004 9000–0x0004 EFFF	Block 0 SRAM 0x0008 C000–0x0009 3FFF	Block 0 SRAM 0x0009 2000–0x0009 DFFF	Block 0 SRAM 0x0012 4000–0x0013 BFFF
Reserved 0x0004 F000–0x0004 FFFF	Reserved 0x0009 4000–0x0009 FFFF	Reserved 0x0009 E000–0x0009 FFFF	Reserved 0x0013 C000–0x0013 FFFF
Block 1 ROM (Reserved) 0x0005 0000–0x0005 7FFF	Block 1 ROM (Reserved) 0x000A 0000–0x000A AAA9	Block 1 ROM (Reserved) 0x000A 0000–0x000A FFFF	Block 1 ROM (Reserved) 0x0014 0000–0x0015 FFFF
Reserved 0x0005 8000–0x0005 8FFF	Reserved 0x000A AAAA–0x000A BFFF	Reserved 0x000B 0000–0x000B 1FFF	Reserved 0x0016 0000–0x0016 3FFF
Block 1 SRAM 0x0005 9000–0x0005 EFFF	Block 1 SRAM 0x000A C000–0x000B 3FFF	Block 1 SRAM 0x000B 2000–0x000B DFFF	Block 1 SRAM 0x0016 4000–0x0017 BFFF
Reserved 0x0005 F000–0x0005 FFFF	Reserved 0x000B 4000–0x000B FFFF	Reserved 0x000B E000–0x000B FFFF	Reserved 0x0017 C000–0x0017 FFFF
Block 2 SRAM 0x0006 0000–0x0006 3FFF	Block 2 SRAM 0x000C 0000–0x000C 5554	Block 2 SRAM 0x000C 0000–0x000C 7FFF	Block 2 SRAM 0x0018 0000–0x0018 FFFF
Reserved 0x0006 4000–0x0006 FFFF	Reserved 0x000C 5555–0x000D FFFF	Reserved 0x000C 8000–0x000D FFFF	Reserved 0x0019 0000–0x001B FFFF
Block 3 SRAM 0x0007 0000–0x0007 3FFF	Block 3 SRAM 0x000E 0000–0x000E 5554	Block 3 SRAM 0x000E 0000–0x000E 7FFF	Block 3 SRAM 0x001C 0000–0x001C FFFF
Reserved 0x0007 4000–0x0007 FFFF	Reserved 0x000E 5555–0x000F FFFF	Reserved 0x000E 8000–0x000F FFFF	Reserved 0x001D 0000–0x001F FFFF

¹ Some ADSP-2148x processors include a customer-definable ROM block and are not reserved as shown on this table. Please contact your Analog Devices sales representative for additional details.

instruction that retrieves 48-bit memory. The 32-bit section describes what this address range looks like to an instruction that retrieves 32-bit memory.

ROM Based Security

The ADSP-2148x has a ROM security feature that provides hardware support for securing user software code by preventing unauthorized reading from the internal code. When using this feature, the processor does not boot-load any external code, executing exclusively from internal ROM. Additionally, the processor is not freely accessible via the JTAG port. Instead, a unique 64-bit key, which must be scanned in through the JTAG or Test Access Port will be assigned to each customer. The device will ignore a wrong key. Emulation features are available after the correct key is scanned.

On-Chip Memory Bandwidth

The internal memory architecture allows programs to have four accesses at the same time to any of the four blocks (assuming there are no block conflicts). The total bandwidth is realized using the DMD and PMD buses (2 × 64-bits, CCLK speed) and the IOD0/1 buses (2 × 32-bit, PCLK speed).

FAMILY PERIPHERAL ARCHITECTURE

The ADSP-2148x family contains a rich set of peripherals that support a wide variety of applications including high quality audio, medical imaging, communications, military, test equipment, 3D graphics, speech recognition, motor control, imaging, and other applications.

External Memory

The external port interface supports access to the external memory through core and DMA accesses. The external memory address space is divided into four banks. Any bank can be programmed as either asynchronous or synchronous memory. The external ports are comprised of the following modules.

- An Asynchronous Memory Interface which communicates with SRAM, FLASH, and other devices that meet the standard asynchronous SRAM access protocol. The AMI supports 6M words of external memory in bank 0 and 8M words of external memory in bank 1, bank 2, and bank 3.
- A SDRAM controller that supports a glueless interface with any of the standard SDRAMs. The SDC supports 62M words of external memory in bank 0, and 64M words of external memory in bank 1, bank 2, and bank 3. NOTE: This feature is not available on the ADSP-21486 product.

The PWM generator is capable of operating in two distinct modes while generating center-aligned PWM waveforms: single-update mode or double-update mode. In single-update mode the duty cycle values are programmable only once per PWM period. This results in PWM patterns that are symmetrical about the midpoint of the PWM period. In double-update mode, a second updating of the PWM registers is implemented at the midpoint of the PWM period. In this mode, it is possible to produce asymmetrical PWM patterns that produce lower harmonic distortion in three-phase PWM inverters.

PWM signals can be mapped to the external port address lines or to the DPI pins.

MediaLB

The automotive models of the ADSP-2148x processors have an MLB interface which allows the processor to function as a media local bus device. It includes support for both 3-pin as well as 5-pin media local bus protocols. It supports speeds up to 1024 FS (49.25 Mbits/sec, FS = 48.1 kHz) and up to 31 logical channels, with up to 124 bytes of data per media local bus frame. For a list of automotive models, see [Automotive Products on Page 66](#).

Digital Applications Interface (DAI)

The digital applications interface (DAI) allows the connection of various peripherals to any of the DAI pins (DAI_P20–1). Programs make these connections using the signal routing unit (SRU).

The SRU is a matrix routing unit (or group of multiplexers) that enables the peripherals provided by the DAI to be interconnected under software control. This allows easy use of the DAI associated peripherals for a much wider variety of applications by using a larger set of algorithms than is possible with nonconfigurable signal paths.

The DAI includes eight serial ports, four precision clock generators (PCG), a S/PDIF transceiver, four ASRCs, and an input data port (IDP). The IDP provides an additional input path to the SHARC core, configurable as either eight channels of serial data, or a single 20-bit wide synchronous parallel data acquisition port. Each data channel has its own DMA channel that is independent from the processor's serial ports.

Serial Ports (SPORTs)

The ADSP-2148x features eight synchronous serial ports that provide an inexpensive interface to a wide variety of digital and mixed-signal peripheral devices such as Analog Devices' AD183x family of audio codecs, ADCs, and DACs. The serial ports are made up of two data lines, a clock, and frame sync. The data lines can be programmed to either transmit or receive and each data line has a dedicated DMA channel.

Serial ports can support up to 16 transmit or 16 receive DMA channels of audio data when all eight SPORTs are enabled, or four full duplex TDM streams of 128 channels per frame.

Serial port data can be automatically transferred to and from on-chip memory/external memory via dedicated DMA channels. Each of the serial ports can work in conjunction with

another serial port to provide TDM support. One SPORT provides two transmit signals while the other SPORT provides the two receive signals. The frame sync and clock are shared.

Serial ports operate in five modes:

- Standard serial mode
- Multichannel (TDM) mode
- I²S mode
- Packed I²S mode
- Left-justified mode

S/PDIF-Compatible Digital Audio Receiver/Transmitter

The S/PDIF receiver/transmitter has no separate DMA channels. It receives audio data in serial format and converts it into a biphasic encoded signal. The serial data input to the receiver/transmitter can be formatted as left-justified, I²S or right-justified with word widths of 16, 18, 20, or 24 bits.

The serial data, clock, and frame sync inputs to the S/PDIF receiver/transmitter are routed through the signal routing unit (SRU). They can come from a variety of sources, such as the SPORTs, external pins, or the precision clock generators (PCGs), and are controlled by the SRU control registers.

Asynchronous Sample Rate Converter (SRC)

The asynchronous sample rate converter contains four SRC blocks and is the same core as that used in the AD1896 192 kHz stereo asynchronous sample rate converter and provides up to 128 dB SNR. The SRC block is used to perform synchronous or asynchronous sample rate conversion across independent stereo channels, without using internal processor resources. The four SRC blocks can also be configured to operate together to convert multichannel audio data without phase mismatches. Finally, the SRC can be used to clean up audio data from jittery clock sources such as the S/PDIF receiver.

Input Data Port

The IDP provides up to eight serial input channels—each with its own clock, frame sync, and data inputs. The eight channels are automatically multiplexed into a single 32-bit by eight-deep FIFO. Data is always formatted as a 64-bit frame and divided into two 32-bit words. The serial protocol is designed to receive audio channels in I²S, left-justified sample pair, or right-justified mode.

The IDP also provides a parallel data acquisition port (PDAP), which can be used for receiving parallel data. The PDAP port has a clock input and a hold input. The data for the PDAP can be received from DAI pins or from the external port pins. The PDAP supports a maximum of 20-bit data and four different packing modes to receive the incoming data.

Precision Clock Generators

The precision clock generators (PCG) consist of four units, each of which generates a pair of signals (clock and frame sync) derived from a clock input signal. The units, A, B, C, and D, are identical in functionality and operate independently of each other. The two signals generated by each unit are normally used as a serial bit clock/frame sync pair.

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Delay Line DMA

The processor provides delay line DMA functionality. This allows processor reads and writes to external delay line buffers (and hence to external memory) with limited core interaction.

Scatter/Gather DMA

The processor provides scatter/gather DMA functionality. This allows processor DMA reads/writes to/from non contiguous memory blocks.

FFT Accelerator

The FFT accelerator implements a radix-2 complex/real input, complex output FFT with no core intervention. The FFT accelerator runs at the peripheral clock frequency.

FIR Accelerator

The FIR (finite impulse response) accelerator consists of a 1024 word coefficient memory, a 1024 word deep delay line for the data, and four MAC units. A controller manages the accelerator. The FIR accelerator runs at the peripheral clock frequency.

IIR Accelerator

The IIR (infinite impulse response) accelerator consists of a 1440 word coefficient memory for storage of biquad coefficients, a data memory for storing the intermediate data, and one MAC unit. A controller manages the accelerator. The IIR accelerator runs at the peripheral clock frequency.

Watchdog Timer

The watchdog timer is used to supervise the stability of the system software. When used in this way, software reloads the watchdog timer in a regular manner so that the downward counting timer never expires. An expiring timer then indicates that system software might be out of control.

The 32-bit watchdog timer that can be used to implement a software watchdog function. A software watchdog can improve system reliability by forcing the processor to a known state through generation of a system reset, if the timer expires before being reloaded by software. Software initializes the count value of the timer, and then enables the timer. The watchdog timer resets both the core and the internal peripherals. Note that this feature is available on the 176-lead package only.

SYSTEM DESIGN

The following sections provide an introduction to system design options and power supply issues.

Program Booting

The internal memory of the ADSP-2148x boots at system power-up from an 8-bit EPROM via the external port, an SPI master, or an SPI slave. Booting is determined by the boot configuration (BOOT_CFG2-0) pins in [Table 9](#) for the 176-lead package and [Table 10](#) for the 100-lead package.

Table 9. Boot Mode Selection, 176-Lead Package

BOOT_CFG2-0	Booting Mode
000	SPI Slave Boot
001	SPI Master Boot
010	AMI User Boot (for 8-bit Flash Boot)
011	No boot (processor executes from internal ROM after reset)
1xx	Reserved

Table 10. Boot Mode Selection, 100-Lead Package

BOOT_CFG1-0	Booting Mode
00	SPI Slave Boot
01	SPI Master Boot
10	Reserved
11	No boot (processor executes from internal ROM after reset)

The “Running Reset” feature allows a user to perform a reset of the processor core and peripherals, but without resetting the PLL and SDRAM controller, or performing a boot. The functionality of the RESETOUT/RUNRSTIN pin has now been extended to also act as the input for initiating a Running Reset. For more information, see the hardware reference.

Power Supplies

The processors have separate power supply connections for the internal (V_{DD_INT}) and external (V_{DD_EXT}) power supplies. The internal supply must meet the V_{DD_INT} specifications. The external supply must meet the V_{DD_EXT} specification. All external supply pins must be connected to the same power supply.

To reduce noise coupling, the PCB should use a parallel pair of power and ground planes for V_{DD_INT} and GND.

Static Voltage Scaling (SVS)

Some models of the ADSP-2148x feature Static Voltage Scaling (SVS) on the V_{DD_INT} power supply. (See the [Ordering Guide on Page 66](#) for model details.) This voltage specification technique can provide significant performance benefits including 450 MHz core frequency operation without a significant increase in power.

SVS optimizes the required V_{DD_INT} voltage for each individual device to enable enhanced operating frequency up to 450 MHz. The optimized SVS voltage results in a reduction of maximum I_{DD_INT} which enables 450 MHz operation at the same or lower maximum power than 400 MHz operation at a fixed voltage supply. Implementation of SVS requires a specific voltage regulator circuit design and initialization code.

Refer to the Engineer-to-Engineer Note [Static Voltage Scaling for ADSP-2148x SHARC Processors \(EE-357\)](#) for further information. The EE-Note details the requirements and process to implement a SVS power supply system to enable operation up to 450 MHz. This applies only to specific products within the ADSP-2148x family which are capable of supporting 450 MHz operation.

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Details on power consumption and Static and Dynamic current consumption can be found at [Total Power Dissipation on Page 20](#). Also see [Operating Conditions on Page 18](#) for more information.

The following are SVS features.

- SVS is applicable only to 450 MHz models (not applicable to 400 MHz or lower frequency models).
- Each individual SVS device includes a register (SVS_DAT) containing the unique SVS voltage set at the factory, known as SVS_{NOM}.
- The SVS_{NOM} value is the intended set voltage for the V_{DD_INT} voltage regulator.
- No dedicated pins are required for SVS. The TWI serial bus is used to communicate SVS_{NOM} to the voltage regulator.
- Analog Devices recommends a specific voltage regulator design and initialization code sequence that optimizes the power-up sequence.

The Engineer-to-Engineer Note [Static Voltage Scaling for ADSP-2148x SHARC Processors \(EE-357\)](#) contains the details of the regulator design and the initialization requirements.

- Any differences from the Analog Devices recommended programmable regulator design must be reviewed by Analog Devices to ensure that it meets the voltage accuracy and range requirements.

Target Board JTAG Emulator Connector

Analog Devices DSP Tools product line of JTAG emulators uses the IEEE 1149.1 JTAG test access port of the ADSP-2148x processors to monitor and control the target board processor during emulation. Analog Devices DSP Tools product line of JTAG emulators provides emulation at full processor speed, allowing inspection and modification of memory, registers, and processor stacks. The processor's JTAG interface ensures that the emulator will not affect target system loading or timing.

For complete information on Analog Devices' SHARC DSP Tools product line of JTAG emulator operation, see the appropriate emulator hardware user's guide.

DEVELOPMENT TOOLS

Analog Devices supports its processors with a complete line of software and hardware development tools, including integrated development environments (which include CrossCore[®] Embedded Studio and/or VisualDSP++[®]), evaluation products, emulators, and a wide variety of software add-ins.

Integrated Development Environments (IDEs)

For C/C++ software writing and editing, code generation, and debug support, Analog Devices offers two IDEs.

CrossCore Embedded Studio is based on the Eclipse™ framework. Supporting most Analog Devices processor families, it is the IDE of choice for future processors, including multicore devices. CrossCore Embedded Studio seamlessly integrates available software add-ins to support real time operating sys-

tems, file systems, TCP/IP stacks, USB stacks, algorithmic software modules, and evaluation hardware board support packages. For more information visit www.analog.com/cces.

The other Analog Devices IDE, VisualDSP++, supports processor families introduced prior to the release of CrossCore Embedded Studio. This IDE includes the Analog Devices VDK real time operating system and an open source TCP/IP stack. For more information visit www.analog.com/visualdsp. Note that VisualDSP++ will not support future Analog Devices processors.

EZ-KIT Lite Evaluation Board

For processor evaluation, Analog Devices provides wide range of EZ-KIT Lite[®] evaluation boards. Including the processor and key peripherals, the evaluation board also supports on-chip emulation capabilities and other evaluation and development features. Also available are various EZ-Extenders[®], which are daughter cards delivering additional specialized functionality, including audio and video processing. For more information visit www.analog.com and search on "ezkit" or "ezextender".

EZ-KIT Lite Evaluation Kits

For a cost-effective way to learn more about developing with Analog Devices processors, Analog Devices offer a range of EZ-KIT Lite evaluation kits. Each evaluation kit includes an EZ-KIT Lite evaluation board, directions for downloading an evaluation version of the available IDE(s), a USB cable, and a power supply. The USB controller on the EZ-KIT Lite board connects to the USB port of the user's PC, enabling the chosen IDE evaluation suite to emulate the on-board processor in-circuit. This permits the customer to download, execute, and debug programs for the EZ-KIT Lite system. It also supports in-circuit programming of the on-board Flash device to store user-specific boot code, enabling standalone operation. With the full version of CrossCore Embedded Studio or VisualDSP++ installed (sold separately), engineers can develop software for supported EZ-KITs or any custom system utilizing supported Analog Devices processors.

Software Add-Ins for CrossCore Embedded Studio

Analog Devices offers software add-ins which seamlessly integrate with CrossCore Embedded Studio to extend its capabilities and reduce development time. Add-ins include board support packages for evaluation hardware, various middleware packages, and algorithmic modules. Documentation, help, configuration dialogs, and coding examples present in these add-ins are viewable through the CrossCore Embedded Studio IDE once the add-in is installed.

Board Support Packages for Evaluation Hardware

Software support for the EZ-KIT Lite evaluation boards and EZ-Extender daughter cards is provided by software add-ins called Board Support Packages (BSPs). The BSPs contain the required drivers, pertinent release notes, and select example code for the given evaluation hardware. A download link for a specific BSP is located on the web page for the associated EZ-KIT or EZ-Extender product. The link is found in the Product Download area of the product web page.

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PIN FUNCTION DESCRIPTIONS

Table 11. Pin Descriptions

Name	Type	State During/ After Reset	Description
ADDR ₂₃₋₀	I/O/T (ipu)	High-Z/ driven low (boot)	External Address. The processor outputs addresses for external memory and peripherals on these pins. The ADDR pins can be multiplexed to support the external memory interface address, and FLAGS ₁₅₋₈ (I/O) and PWM (O). After reset, all ADDR pins are in external memory interface mode and FLAG(0-3) pins are in FLAGS mode (default). When configured in the IDP_PDAP_CTL register, IDP channel 0 scans the ADDR ₂₃₋₄ pins for parallel input data.
DATA ₁₅₋₀	I/O/T (ipu)	High-Z	External Data. The data pins can be multiplexed to support the external memory interface data (I/O), and FLAGS ₇₋₀ (I/O).
AMI_ACK	I (ipu)		Memory Acknowledge. External devices can deassert AMI_ACK (low) to add wait states to an external memory access. AMI_ACK is used by I/O devices, memory controllers, or other peripherals to hold off completion of an external memory access.
\overline{MS}_{0-1}	O/T (ipu)	High-Z	Memory Select Lines 0-1. These lines are asserted (low) as chip selects for the corresponding banks of external memory. The \overline{MS}_{1-0} lines are decoded memory address lines that change at the same time as the other address lines. When no external memory access is occurring the \overline{MS}_{1-0} lines are inactive; they are active however when a conditional memory access instruction is executed, when the condition evaluates as true. The \overline{MS}_1 pin can be used in EPORT/FLASH boot mode. For more information, see the hardware reference.
$\overline{AMI_RD}$	O/T (ipu)	High-Z	AMI Port Read Enable. $\overline{AMI_RD}$ is asserted whenever the processor reads a word from external memory.
$\overline{AMI_WR}$	O/T (ipu)	High-Z	AMI Port Write Enable. $\overline{AMI_WR}$ is asserted when the processor writes a word to external memory.
FLAG0/ $\overline{IRQ0}$	I/O (ipu)	FLAG[0] INPUT	FLAG0/Interrupt Request0.
FLAG1/ $\overline{IRQ1}$	I/O (ipu)	FLAG[1] INPUT	FLAG1/Interrupt Request1.
FLAG2/ $\overline{IRQ2}/\overline{MS2}$	I/O (ipu)	FLAG[2] INPUT	FLAG2/Interrupt Request2/Memory Select2.
FLAG3/TMREXP/ $\overline{MS3}$	I/O (ipu)	FLAG[3] INPUT	FLAG3/Timer Expired/Memory Select3.

The following symbols appear in the Type column of this table: **A** = asynchronous, **I** = input, **O** = output, **S** = synchronous, **A/D** = active drive, **O/D** = open drain, and **T** = three-state, **ipd** = internal pull-down resistor, **ipu** = internal pull-up resistor.

The internal pull-up (ipu) and internal pull-down (ipd) resistors are designed to hold the internal path from the pins at the expected logic levels. To pull-up or pull-down the external pads to the expected logic levels, use external resistors. Internal pull-up/pull-down resistors cannot be enabled/disabled and the value of these resistors cannot be programmed. The range of an ipu resistor can be between 26 k Ω –63 k Ω . The range of an ipd resistor can be between 31 k Ω –85k Ω . The three-state voltage of ipu pads will not reach to the full V_{DD_EXT} level; at typical conditions the voltage is in the range of 2.3 V to 2.7 V.

In this table, all pins are LVTTTL compliant with the exception of the thermal diode pins.

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Table 11. Pin Descriptions (Continued)

Name	Type	State During/ After Reset	Description
MLBCLK ¹	I		Media Local Bus Clock. This clock is generated by the MLB controller that is synchronized to the MOST network and provides the timing for the entire MLB interface at 49.152 MHz at FS=48 kHz. When the MLB controller is not used, this pin should be grounded.
MLBDAT ¹	I/O/T in 3 pin mode. I in 5 pin mode.	High-Z	Media Local Bus Data. The MLBDAT line is driven by the transmitting MLB device and is received by all other MLB devices including the MLB controller. The MLBDAT line carries the actual data. In 5-pin MLB mode, this pin is an input only. When the MLB controller is not used, this pin should be grounded.
MLBSIG ¹	I/O/T in 3 pin mode. I in 5 pin mode	High-Z	Media Local Bus Signal. This is a multiplexed signal which carries the Channel/Address generated by the MLB Controller, as well as the Command and RxStatus bytes from MLB devices. In 5-pin mode, this pin is input only. When the MLB controller is not used, this pin should be grounded.
MLBDO ¹	O/T	High-Z	Media Local Bus Data Output (in 5 pin mode). This pin is used only in 5-pin MLB mode. This serves as the output data pin in 5-pin mode. When the MLB controller is not used, this pin should be connected to ground.
MLBSO ¹	O/T	High-Z	Media Local Bus Signal Output (in 5 pin mode). This pin is used only in 5-pin MLB mode. This serves as the output signal pin in 5-pin mode. When the MLB controller is not used, this pin should be connected to ground.
TDI	I (ipu)	High-Z	Test Data Input (JTAG). Provides serial data for the boundary scan logic.
TDO	O/T		Test Data Output (JTAG). Serial scan output of the boundary scan path.
TMS	I (ipu)		Test Mode Select (JTAG). Used to control the test state machine.
TCK	I		Test Clock (JTAG). Provides a clock for JTAG boundary scan. TCK must be asserted (pulsed low) after power-up or held low for proper operation of the device.
$\overline{\text{TRST}}$	I (ipu)		Test Reset (JTAG). Resets the test state machine. $\overline{\text{TRST}}$ must be asserted (pulsed low) after power-up or held low for proper operation of the processor.
$\overline{\text{EMU}}$	O (O/D, ipu)	High-Z	Emulation Status. Must be connected to the ADSP-2148x Analog Devices DSP Tools product line of JTAG emulators target board connector only.

The following symbols appear in the Type column of this table: **A** = asynchronous, **I** = input, **O** = output, **S** = synchronous, **A/D** = active drive, **O/D** = open drain, and **T** = three-state, **ipd** = internal pull-down resistor, **ipu** = internal pull-up resistor.

The internal pull-up (ipu) and internal pull-down (ipd) resistors are designed to hold the internal path from the pins at the expected logic levels. To pull-up or pull-down the external pads to the expected logic levels, use external resistors. Internal pull-up/pull-down resistors cannot be enabled/disabled and the value of these resistors cannot be programmed. The range of an ipu resistor can be between 26 k Ω –63 k Ω . The range of an ipd resistor can be between 31 k Ω –85k Ω . The three-state voltage of ipu pads will not reach to the full V_{DD_EXT} level; at typical conditions the voltage is in the range of 2.3 V to 2.7 V.

In this table, all pins are LVTTTL compliant with the exception of the thermal diode pins.

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ELECTRICAL CHARACTERISTICS

Parameter ¹	Description	Test Conditions	300 MHz / 350 MHz / 400 MHz / 450 MHz			Unit
			Min	Typ	Max	
V _{OH} ²	High Level Output Voltage	@ V _{DD_EXT} = Min, I _{OH} = -1.0 mA ³	2.4			V
V _{OL} ²	Low Level Output Voltage	@ V _{DD_EXT} = Min, I _{OL} = 1.0 mA ³			0.4	V
I _{IH} ^{4,5}	High Level Input Current	@ V _{DD_EXT} = Max, V _{IN} = V _{DD_EXT} Max			10	μA
I _{IL} ⁴	Low Level Input Current	@ V _{DD_EXT} = Max, V _{IN} = 0 V			10	μA
I _{ILPU} ⁵	Low Level Input Current Pull-up	@ V _{DD_EXT} = Max, V _{IN} = 0 V			200	μA
I _{OZH} ^{6,7}	Three-State Leakage Current	@ V _{DD_EXT} = Max, V _{IN} = V _{DD_EXT} Max			10	μA
I _{OZL} ⁶	Three-State Leakage Current	@ V _{DD_EXT} = Max, V _{IN} = 0 V			10	μA
I _{OZLPU} ⁷	Three-State Leakage Current Pull-up	@ V _{DD_EXT} = Max, V _{IN} = 0 V			200	μA
I _{OZHPD} ⁸	Three-State Leakage Current Pull-down	@ V _{DD_EXT} = Max, V _{IN} = V _{DD_EXT} Max			200	μA
I _{DD_INT} ⁹	Supply Current (Internal)	f _{CCLK} > 0 MHz			Table 14 + Table 15 × ASF	mA
I _{DD_INT}	Supply Current (Internal)	V _{DDINT} = 1.1 V, ASF = 1, T _J = 25°C		410 / 450 / 500 / 550		mA
C _{IN} ^{10, 11}	Input Capacitance	T _{CASE} = 25°C			5	pF

¹ Specifications subject to change without notice.

² Applies to output and bidirectional pins: ADDR23-0, DATA15-0, AMI_RD, AMI_WR, FLAG3-0, DAL_Px, DPI_Px, EMU, TDO, RESETOUT, MLBSIG, MLBDAT, MLBDO, MLBSO, SDRAS, SDCAS, SDWE, SDCKE, SDA10, SDDQM, MS0-I.

³ See [Output Drive Currents on Page 55](#) for typical drive current capabilities.

⁴ Applies to input pins: BOOT_CFGx, CLK_CFGx, TCK, RESET, CLKIN.

⁵ Applies to input pins with internal pull-ups: TRST, TMS, TDI.

⁶ Applies to three-statable pin: TDO.

⁷ Applies to three-statable pins with pull-ups: DAL_Px, DPI_Px, EMU.

⁸ Applies to three-statable pin with pull-down: SDCLK.

⁹ See Engineer-to-Engineer Note [Estimating Power for ADSP-214xx SHARC Processors \(EE-348\)](#) for further information.

¹⁰ Applies to all signal pins.

¹¹ Guaranteed, but not tested.

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TIMING SPECIFICATIONS

Use the exact timing information given. Do not attempt to derive parameters from the addition or subtraction of others. While addition or subtraction would yield meaningful results for an individual device, the values given in this data sheet reflect statistical variations and worst cases. Consequently, it is not meaningful to add parameters to derive longer times. See [Figure 43 on Page 55](#) for voltage reference levels.

Switching characteristics specify how the processor changes its signals. Circuitry external to the processor must be designed for compatibility with these signal characteristics. Switching characteristics describe what the processor will do in a given circumstance. Use switching characteristics to ensure that any timing requirement of a device connected to the processor (such as memory) is satisfied.

Timing requirements apply to signals that are controlled by circuitry external to the processor, such as the data input for a read operation. Timing requirements guarantee that the processor operates correctly with other devices.

Core Clock Requirements

The processor's internal clock (a multiple of CLKIN) provides the clock signal for timing internal memory, the processor core, and the serial ports. During reset, program the ratio between the processor's internal clock frequency and external (CLKIN) clock frequency with the CLK_CFG1-0 pins.

The processor's internal clock switches at higher frequencies than the system input clock (CLKIN). To generate the internal clock, the processor uses an internal phase-locked loop (PLL, see [Figure 4](#)). This PLL-based clocking minimizes the skew between the system clock (CLKIN) signal and the processor's internal clock.

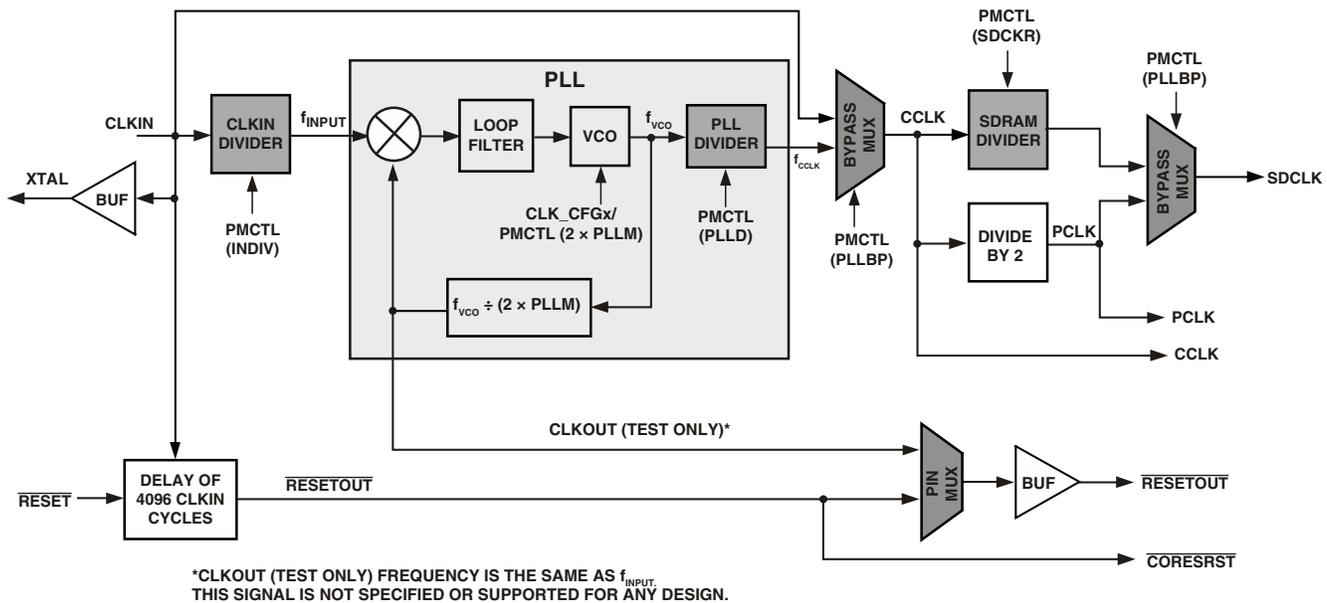


Figure 4. Core Clock and System Clock Relationship to CLKIN

Voltage Controlled Oscillator (VCO)

In application designs, the PLL multiplier value should be selected in such a way that the VCO frequency never exceeds f_{VCO} specified in [Table 20](#).

- The product of CLKIN and PLLM must never exceed 1/2 of f_{VCO} (max) in [Table 20](#) if the input divider is not enabled (INDIV = 0).
- The product of CLKIN and PLLM must never exceed f_{VCO} (max) in [Table 20](#) if the input divider is enabled (INDIV = 1).

The VCO frequency is calculated as follows:

$$f_{VCO} = 2 \times PLLM \times f_{INPUT}$$

$$f_{CCLK} = (2 \times PLLM \times f_{INPUT}) \div PLLD$$

where:

f_{VCO} = VCO output

PLLM = Multiplier value programmed in the PMCTL register. During reset, the PLLM value is derived from the ratio selected using the CLK_CFG pins in hardware.

PLLD = 2, 4, 8, or 16 based on the divider value programmed on the PMCTL register. During reset this value is 2.

f_{INPUT} = is the input frequency to the PLL.

f_{INPUT} = CLKIN when the input divider is disabled or

f_{INPUT} = CLKIN \div 2 when the input divider is enabled

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Watchdog Timer Timing

Table 27. Watchdog Timer Timing

Parameter	Min	Max	Unit
<i>Timing Requirement</i>			
$t_{WDCLKPER}$	100	1000	ns
<i>Switching Characteristics</i>			
t_{RST}	WDT Clock Rising Edge to Watchdog Timer RESET Falling Edge		ns
t_{RSTPW}	Reset Pulse Width		$64 \times t_{WDCLKPER}$ ns

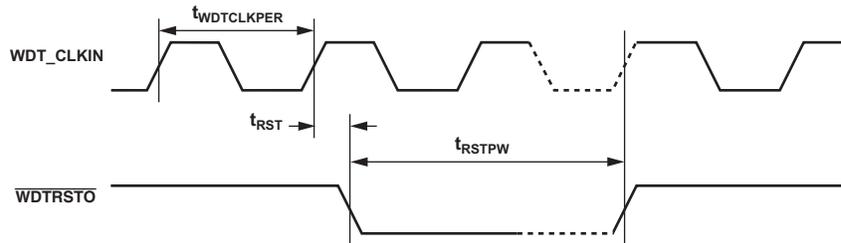


Figure 14. Watchdog Timer Timing

Pin to Pin Direct Routing (DAI and DPI)

For direct pin connections only (for example DAI_PB01_I to DAI_PB02_O).

Table 28. DAI/DPI Pin to Pin Routing

Parameter	Min	Max	Unit
<i>Timing Requirement</i>			
t_{DPIO}	Delay DAI/DPI Pin Input Valid to DAI/DPI Output Valid		ns

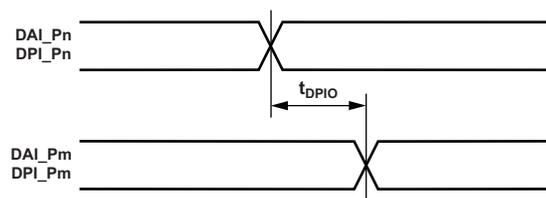


Figure 15. DAI Pin to Pin Direct Routing

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Precision Clock Generator (Direct Pin Routing)

This timing is only valid when the SRU is configured such that the precision clock generator (PCG) takes its inputs directly from the DAI pins (via pin buffers) and sends its outputs directly to the DAI pins. For the other cases, where the PCG's

inputs and outputs are not directly routed to/from DAI pins (via pin buffers), there is no timing data available. All timing parameters and switching characteristics apply to external DAI pins (DAI_P01 – DAI_P20).

Table 29. Precision Clock Generator (Direct Pin Routing)

Parameter	Min	Max	Unit
<i>Timing Requirements</i>			
t_{PCGIW} Input Clock Period	$t_{PCLK} \times 4$		ns
t_{STRIG} PCG Trigger Setup Before Falling Edge of PCG Input Clock	4.5		ns
t_{HTRIG} PCG Trigger Hold After Falling Edge of PCG Input Clock	3		ns
<i>Switching Characteristics</i>			
t_{DPCGIO} PCG Output Clock and Frame Sync Active Edge Delay After PCG Input Clock	2.5	10	ns
$t_{DTRIGCLK}$ PCG Output Clock Delay After PCG Trigger	$2.5 + (2.5 \times t_{PCGIP})$	$10 + (2.5 \times t_{PCGIP})$	ns
$t_{DTRIGFS}$ PCG Frame Sync Delay After PCG Trigger	$2.5 + ((2.5 + D - PH) \times t_{PCGIP})$	$10 + ((2.5 + D - PH) \times t_{PCGIP})$	ns
t_{PCGOW}^1 Output Clock Period	$2 \times t_{PCGIP} - 1$		ns

D = FSxDIV, PH = FSxPHASE. For more information, see the "Precision Clock Generators" chapter in the hardware reference.

¹Normal mode of operation.

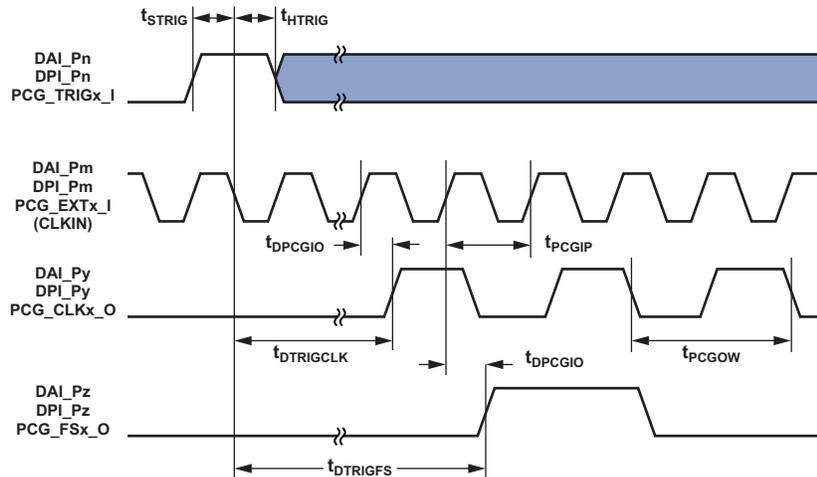


Figure 16. Precision Clock Generator (Direct Pin Routing)

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Flags

The timing specifications provided below apply to the DPI_P14-1, ADDR7-0, ADDR23-8, DATA7-0, and FLAG3-0 pins when configured as FLAGS. See [Table 11 on Page 14](#) for more information on flag use.

Table 30. Flags

Parameter	Min	Max	Unit
<i>Timing Requirement</i>			
t_{FIPW}^1 FLAGs IN Pulse Width	$2 \times t_{PCLK} + 3$		ns
<i>Switching Characteristic</i>			
t_{FOPW}^1 FLAGs OUT Pulse Width	$2 \times t_{PCLK} - 3$		ns

¹This is applicable when the Flags are connected to DPI_P14-1, ADDR7-0, ADDR23-8, DATA7-0 and FLAG3-0 pins.

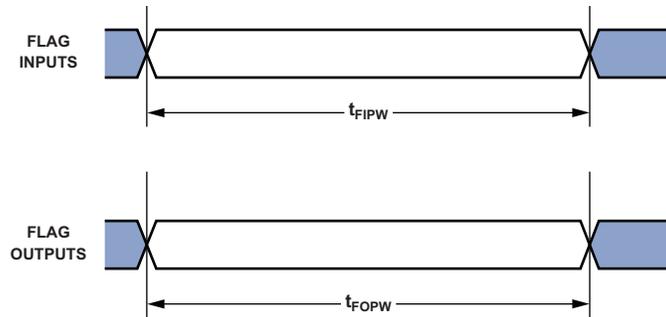


Figure 17. Flags

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AMI Write

Use these specifications for asynchronous interfacing to memories. Note that timing for AMI_ACK, ADDR, DATA, AMI_RD, AMI_WR, and strobe timing parameters only apply to asynchronous access mode.

Table 33. AMI Write

Parameter	Min	Max	Unit
<i>Timing Requirements</i>			
$t_{DAAK}^{1,2}$ AMI_ACK Delay from Address, Selects		$t_{SDCLK} - 9.7 + W$	ns
$t_{DSAK}^{1,3}$ AMI_ACK Delay from $\overline{AMI_WR}$ Low		$W - 6$	ns
<i>Switching Characteristics</i>			
t_{DAWH}^2 Address Selects to $\overline{AMI_WR}$ Deasserted	$t_{SDCLK} - 3.1 + W$		ns
t_{DAWL}^2 Address Selects to $\overline{AMI_WR}$ Low	$t_{SDCLK} - 3$		ns
t_{WW} $\overline{AMI_WR}$ Pulse Width	$W - 1.3$		ns
t_{DDWH} Data Setup Before $\overline{AMI_WR}$ High	$t_{SDCLK} - 3.7 + W$		ns
t_{DWHA} Address Hold After $\overline{AMI_WR}$ Deasserted	$H + 0.15$		ns
t_{DWHd} Data Hold After $\overline{AMI_WR}$ Deasserted	H		ns
t_{DATRWH}^4 Data Disable After $\overline{AMI_WR}$ Deasserted	$t_{SDCLK} - 4.3 + H$	$t_{SDCLK} + 4.9 + H$	ns
t_{WWR}^5 $\overline{AMI_WR}$ High to $\overline{AMI_WR}$ Low	$t_{SDCLK} - 1.5 + H$		ns
t_{DDWR} Data Disable Before $\overline{AMI_RD}$ Low	$2 \times t_{SDCLK} - 6$		ns
t_{WDE} Data Enabled to $\overline{AMI_WR}$ Low	$t_{SDCLK} - 3.7$		ns

$W = (\text{number of wait states specified in AMICTLx register}) \times t_{SDCLK}$

$H = (\text{number of hold cycles specified in AMICTLx register}) \times t_{SDCLK}$

¹ AMI_ACK delay/setup: System must meet t_{DAAK} , or t_{DSAK} , for deassertion of AMI_ACK (low).

² The falling edge of \overline{MSx} is referenced.

³ Note that timing for AMI_ACK, AMI_RD, $\overline{AMI_WR}$, and strobe timing parameters only applies to asynchronous access mode.

⁴ See Test Conditions on Page 55 for calculation of hold times given capacitive and dc loads.

⁵ For Write to Write: $t_{SDCLK} + H$, for both same bank and different bank. For Write to Read: $3 \times t_{SDCLK} + H$, for the same bank and different banks.

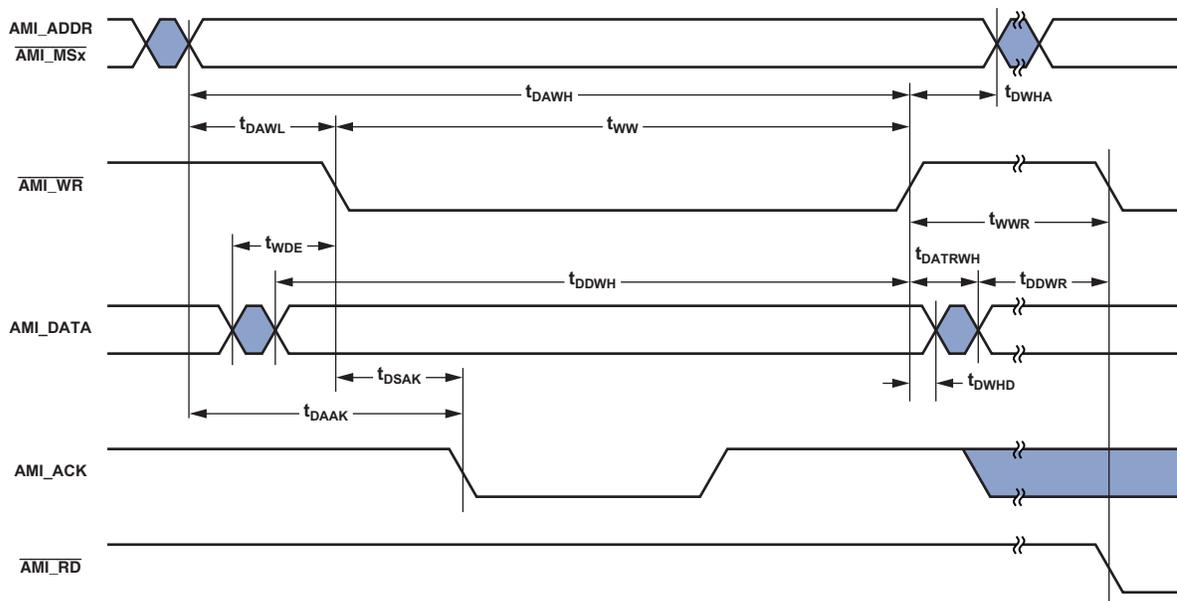


Figure 20. AMI Write

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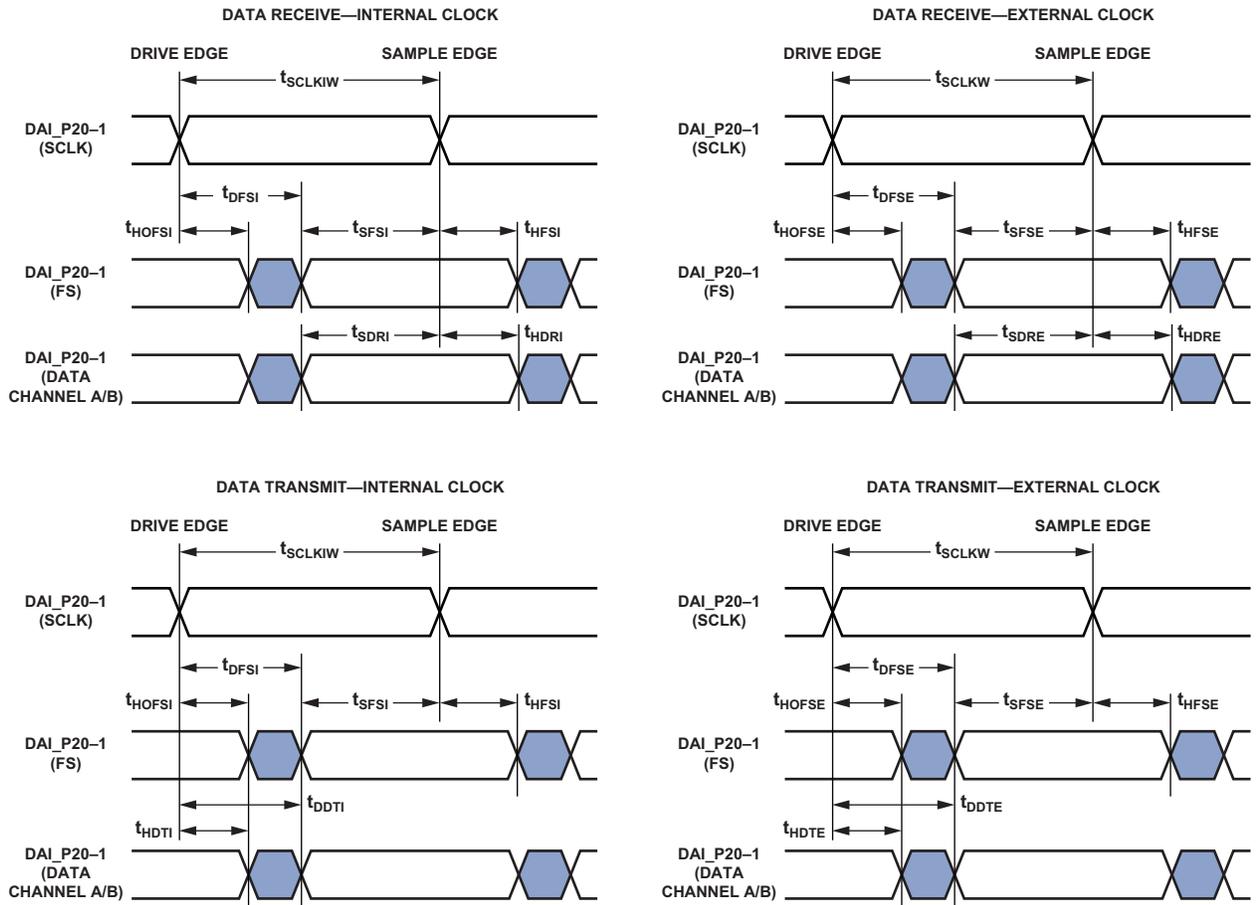


Figure 21. Serial Ports

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Figure 31 shows the default I²S-justified mode. The frame sync is low for the left channel and HI for the right channel. Data is valid on the rising edge of serial clock. The MSB is left-justified to the frame sync transition but with a delay.

Table 45. S/PDIF Transmitter I²S Mode

Parameter	Nominal	Unit
<i>Timing Requirement</i>		
t_{I2SD} Frame Sync to MSB Delay in I ² S Mode	1	SCLK

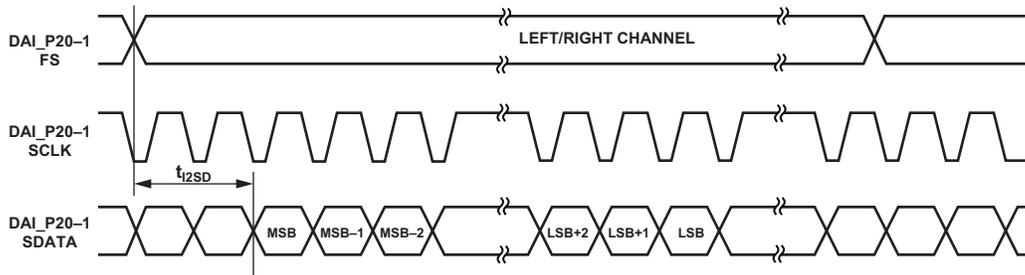


Figure 31. I²S-Justified Mode

Figure 32 shows the left-justified mode. The frame sync is high for the left channel and low for the right channel. Data is valid on the rising edge of serial clock. The MSB is left-justified to the frame sync transition with no delay.

Table 46. S/PDIF Transmitter Left-Justified Mode

Parameter	Nominal	Unit
<i>Timing Requirement</i>		
t_{LJD} Frame Sync to MSB Delay in Left-Justified Mode	0	SCLK

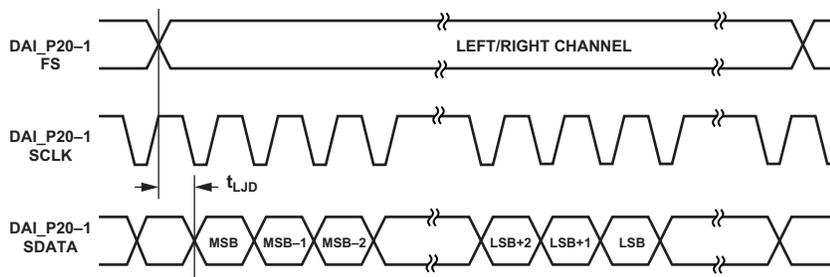


Figure 32. Left-Justified Mode

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S/PDIF Receiver

The following section describes timing as it relates to the S/PDIF receiver.

Internal Digital PLL Mode

In the internal digital phase-locked loop mode the internal PLL (digital PLL) generates the $512 \times FS$ clock.

Table 49. S/PDIF Receiver Internal Digital PLL Mode Timing

Parameter	Min	Max	Unit
<i>Switching Characteristics</i>			
t_{DFSI}		5	ns
t_{HOFSI}	-2		ns
t_{DDTI}		5	ns
t_{HDTI}	-2		ns
t_{SCLKIW}^1	$8 \times t_{PCLK} - 2$		ns

¹ SCLK frequency is $64 \times FS$ where FS = the frequency of frame sync.

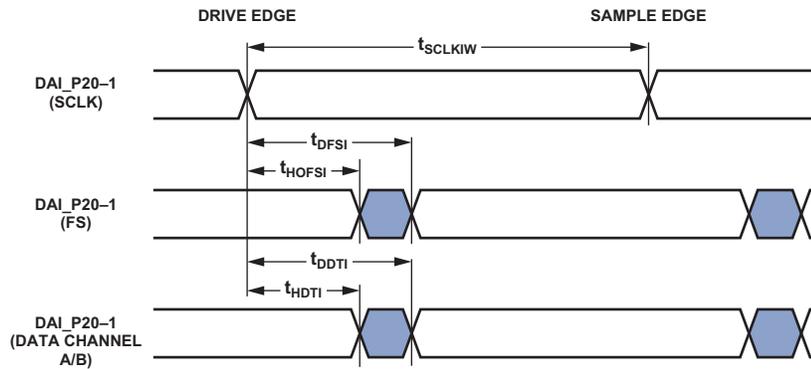


Figure 34. S/PDIF Receiver Internal Digital PLL Mode Timing

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100-LQFP_EP LEAD ASSIGNMENT

Table 59. 100-Lead LQFP_EP Lead Assignments (Numerical by Lead Number)

Lead Name	Lead No.	Lead Name	Lead No.	Lead Name	Lead No.	Lead Name	Lead No.
VDD_INT	1	VDD_EXT	26	DAI_P10	51	VDD_INT	76
CLK_CFG1	2	DPI_P08	27	VDD_INT	52	FLAG0	77
BOOT_CFG0	3	DPI_P07	28	VDD_EXT	53	VDD_INT	78
VDD_EXT	4	VDD_INT	29	DAI_P20	54	VDD_INT	79
VDD_INT	5	DPI_P09	30	VDD_INT	55	FLAG1	80
BOOT_CFG1	6	DPI_P10	31	DAI_P08	56	FLAG2	81
GND	7	DPI_P11	32	DAI_P04	57	FLAG3	82
NC	8	DPI_P12	33	DAI_P14	58	MLBCLK	83
NC	9	DPI_P13	34	DAI_P18	59	MLBDAT	84
CLK_CFG0	10	DAI_P03	35	DAI_P17	60	MLBDO	85
VDD_INT	11	DPI_P14	36	DAI_P16	61	VDD_EXT	86
CLKIN	12	VDD_INT	37	DAI_P15	62	MLBSIG	87
XTAL	13	VDD_INT	38	DAI_P12	63	VDD_INT	88
VDD_EXT	14	VDD_INT	39	VDD_INT	64	MLBSO	89
VDD_INT	15	DAI_P13	40	DAI_P11	65	$\overline{\text{TRST}}$	90
VDD_INT	16	DAI_P07	41	VDD_INT	66	$\overline{\text{EMU}}$	91
$\overline{\text{RESETOUT}}/\text{RUNRSTIN}$	17	DAI_P19	42	VDD_INT	67	TDO	92
VDD_INT	18	DAI_P01	43	GND	68	VDD_EXT	93
DPI_P01	19	DAI_P02	44	THD_M	69	VDD_INT	94
DPI_P02	20	VDD_INT	45	THD_P	70	TDI	95
DPI_P03	21	VDD_EXT	46	VDD_THD	71	TCK	96
VDD_INT	22	VDD_INT	47	VDD_INT	72	VDD_INT	97
DPI_P05	23	DAI_P06	48	VDD_INT	73	$\overline{\text{RESET}}$	98
DPI_P04	24	DAI_P05	49	VDD_INT	74	TMS	99
DPI_P06	25	DAI_P09	50	VDD_INT	75	VDD_INT	100
						GND	101*

MLB pins (pins 83, 84, 85, 87, and 89) are available for automotive models only. For non-automotive models, these pins should be connected to ground (GND).

* Pin no. 101 (exposed pad) is the GND supply (see [Figure 48](#) and [Figure 49](#)) for the processor; this pad must be **robustly** connected to GND.

ADSP-21483/ADSP-21486/ADSP-21487/ADSP-21488/ADSP-21489

AUTOMOTIVE PRODUCTS

The following models are available with controlled manufacturing to support the quality and reliability requirements of automotive applications. Note that these automotive models may have specifications that differ from the commercial models and designers should review the product [Specifications on](#)

[Page 18](#) section of this data sheet carefully. Only the automotive grade products shown in [Table 63](#) are available for use in automotive applications. Contact your local ADI account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for these models.

Table 63. Automotive Products

Model ^{1, 2, 3, 4}	Notes	Temperature Range ⁵	RAM	Processor Instruction Rate (Max)	Package Description	Package Option
AD21486WBSWZ4Axx	⁶	-40°C to +85°C	5 Mbit	400 MHz	100-Lead LQFP_EP	SW-100-2
AD21487WBSWZ4Axx	⁶	-40°C to +85°C	5 Mbit	400 MHz	100-Lead LQFP_EP	SW-100-2
AD21487WBSWZ4Bxx	⁶	-40°C to +85°C	5 Mbit	400 MHz	176-Lead LQFP_EP	SW-176-2
AD21488WBSWZ1Axx		-40°C to +85°C	3 Mbit	266 MHz	100-Lead LQFP_EP	SW-100-2
AD21488WBSWZ2Axx		-40°C to +85°C	3 Mbit	300 MHz	100-Lead LQFP_EP	SW-100-2
AD21488WBSWZ1Bxx		-40°C to +85°C	2 Mbit	266 MHz	176-Lead LQFP_EP	SW-176-2
AD21488WBSWZ2Bxx		-40°C to +85°C	3 Mbit	266 MHz	176-Lead LQFP_EP	SW-176-2
AD21488WBSWZ4Bxx		-40°C to +85°C	3 Mbit	400 MHz	176-Lead LQFP_EP	SW-176-2
AD21489WBSWZ4xx		-40°C to +85°C	5 Mbit	400 MHz	100-Lead LQFP_EP	SW-100-2
AD21489WBSWZ4xxRL		-40°C to +85°C	5 Mbit	400 MHz	100-Lead LQFP_EP	SW-100-2
AD21489WBSWZ4Bxx		-40°C to +85°C	5 Mbit	400 MHz	176-Lead LQFP_EP	SW-176-2

¹Z =RoHS Compliant Part.

²W = automotive applications.

³xx denotes the current die revision.

⁴RL = Tape and Reel.

⁵Referenced temperature is ambient temperature. The ambient temperature is not a specification. Please see [Operating Conditions on Page 18](#) for junction temperature (T_j) specification which is the only temperature specification.

⁶This product contains IP from Dolby, DTS and DTLA. Proper software licenses required. Contact Analog Devices, Inc. for information.

ORDERING GUIDE

Model ¹	Notes	Temperature Range ²	RAM	Processor Instruction Rate (Max)	Package Description	Package Option
ADSP-21483KSWZ-2B	³	0°C to +70°C	3 Mbit	300 MHz	176-Lead LQFP_EP	SW-176-2
ADSP-21483KSWZ-3B	³	0°C to +70°C	3 Mbit	350 MHz	176-Lead LQFP_EP	SW-176-2
ADSP-21483KSWZ-3AB	³	0°C to +70°C	3 Mbit	350 MHz	100-Lead LQFP_EP	SW-100-2
ADSP-21483KSWZ-4B	³	0°C to +70°C	3 Mbit	400 MHz	176-Lead LQFP_EP	SW-176-2
ADSP-21486KSWZ-2A	³	0°C to +70°C	5 Mbit	300 MHz	100-Lead LQFP_EP	SW-100-2
ADSP-21486KSWZ-2B	³	0°C to +70°C	5 Mbit	300 MHz	176-Lead LQFP_EP	SW-176-2
ADSP-21486KSWZ-2AB	³	0°C to +70°C	5 Mbit	300 MHz	100-Lead LQFP_EP	SW-100-2
ADSP-21486KSWZ-2BB	³	0°C to +70°C	5 Mbit	300 MHz	176-Lead LQFP_EP	SW-176-2
ADSP-21486KSWZ-3A	³	0°C to +70°C	5 Mbit	350 MHz	100-Lead LQFP_EP	SW-100-2
ADSP-21486KSWZ-3B	³	0°C to +70°C	5 Mbit	350 MHz	176-Lead LQFP_EP	SW-176-2
ADSP-21486KSWZ-3AB	³	0°C to +70°C	5 Mbit	350 MHz	100-Lead LQFP_EP	SW-100-2
ADSP-21486KSWZ-3BB	³	0°C to +70°C	5 Mbit	350 MHz	176-Lead LQFP_EP	SW-176-2
ADSP-21486KSWZ-4A	³	0°C to +70°C	5 Mbit	400 MHz	100-Lead LQFP_EP	SW-100-2
ADSP-21486KSWZ-4AB	³	0°C to +70°C	5 Mbit	400 MHz	100-Lead LQFP_EP	SW-100-2